

E2

 \oplus 0.10

8X **b**

 \oplus

(0.20)

CAB

0.10 C A B

С 0.05

NOTE 3

BOTTOM VIEW

|||

4X

(0.25)**AUXILIARY BOTTOM VIEW** (FOR REFERENCE ONLY)

е

(0.28)(0.825)

(0.50)

e/2

DATE 05 NOV 2008

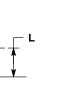
- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION b APPLIES TO PLATED TERMINAL
- AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM TERMINAL.
- U.3U mm FHOM I EHMINAL.
 COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
 EXPOSED ENDS OF THE TERMINALS ARE ELECTRICALLY ACTIVE.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.80	1.00	
A1	0.00	0.05	
А3	0.20 REF		
b	0.15	0.25	
D	2.20 BSC		
D2	0.34	0.54	
E	2.00 BSC		
E2	0.60	0.80	
е	0.50 BSC		
K	0.20		
L	0.30	0.50	
L1		0.15	



DETAIL A

OPTIONAL CONSTRUCTIONS

GENERIC MARKING DIAGRAM*



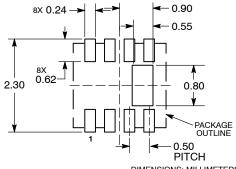
XX = Specific Device Code

= Date Code

= Pb-Free Device

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present.

SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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